

PCB Design Job Specifications

Client/ Company	Date
Project	
Board Name	Board No.
Design Engineer	

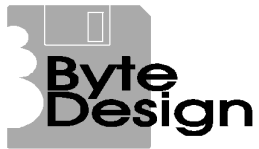
CAD System	version
Design Units	metric
	imperial

Board Specs:

Dimensions:						
Edge Connector						
Board Thickness	0.8	1.2	1.6	2.4	3.2	
Board Material	FR4					
Panellisation						
Profiling	V-Groove		Routing			
Stack-up	SS			DS		
	ML Signal			ML Plane		
Track width/spacing						
vias	size			type		
Copper thickness	1/4oz	1/2oz	1oz	2oz		
Board finish	HASL	OSP	Gold			
Solder Resist Mask	Primary	Secondary	Colour			
Component Legend	Primary	Secondary	Colour			
Fiducial Requirements	Component		Board		Panel	
Board Marking						
Special Requirements:						

Assembly Requirements:

Component mount side	Primary	Secondary	
Solder method	Wave	Reflow	Hand
	Wave/Reflow	Reflow/Reflow	
Component Insertion	Hand	Machine	
Solder Paste			
Special Requirements:			



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Signal Requirements:

High Current Nets		
High Voltage Nets		
Controlled Impedance		
Differential Nets		
High Speed Nets		
EMC		
Net Classes	Track Width	Clearance

Test Requirements:

ICT		
Test Pad size	Test Pad to Test Pad Clearance	
Special Requirements:		

Thermal Requirements:

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